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Schottky Barrier Diode NSR01L30MX

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current.

Features

- Very Low Forward Voltage Drop 350 mV @ 1 mA
- Low Reverse Current 0.2 μA @ 10 V
- 100 mA of Continuous Forward Current
- ESD Rating Human Body Model: Class 3B – Machine Model: Class C
- This is a Halide–Free Device
- This is a Pb–Free Device

Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc–dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

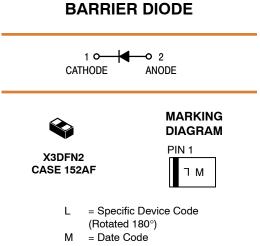
Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	30	V
Forward Current (DC)	١ _F	100	mA
Forward Surge Current (60 Hz @ 1 cycle)	I _{FSM}	2.0	A
ESD Rating: Human Body Model	HBM	Class 1B (500 ≤ Failure < 1000)	V
Charge Device Model	CDM	C3 (JEDEC) (Failure ≥ 1000)	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



30 V SCHOTTKY

ORDERING INFORMATION

Device	Package	Shipping†
NSR01L30MXT5G	X3DFN2 (Pb-Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR01L30MX

THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			695 180	°C/W mW
Storage Temperature Range	T _{stg}			–55 to +150	°C
Junction Temperature	TJ			+150	°C

1. Mounted onto a 4 in square FR-4 board 100 mm sq. 2 oz. Cu 0.06" thick single-sided. Operating to steady state.

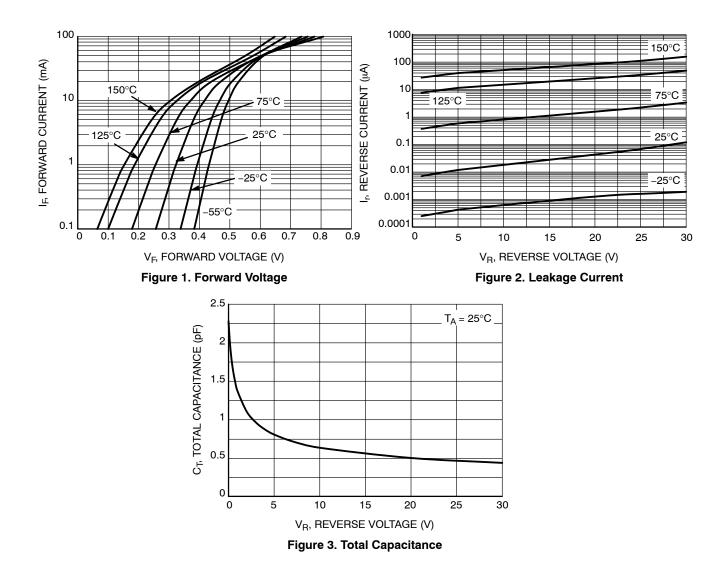
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 10 V)$ $(V_R = 30 V)$	I _R			0.2 0.5	μΑ
Forward Voltage $(I_F = 1 \text{ mA})$ $(I_F = 10 \text{ mA})$	V _F			0.35 0.46	V
Total Capacitance (V _R = 5.0 V, f = 1 MHz)	СТ		0.8		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

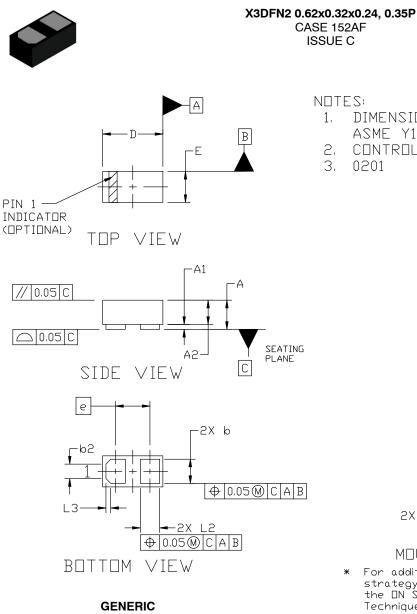
NSR01L30MX

TYPICAL CHARACTERISTICS

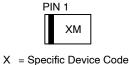


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MARKING DIAGRAM*



M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

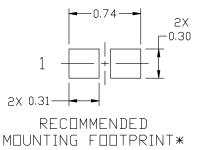
DOCUMENT NUMBER:	98AON56472E Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	X3DFN2 0.62x0.32x0.24, 0.35P		PAGE 1 OF 1

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- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION MILLIMETERS

r	1			
	MILLIMETERS			
DIM	MIN,	NDM.	MAX.	
А	0.25	0.29	0.33	
A1	0.00		0.05	
A2	0.14	0.24	0.34	
b	0.22	0.25	0.28	
b2	0.150 REF			
D	0.58	0.62	0.66	
E	0.28	0.32	0.36	
e	0.355 BSC			
L2	0.17	0.20	0.23	
L3	0.050 REF			



* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>